About TI India
Texas Instruments (TI) recognized the value of India for global research and development (R&D) as early as in 1985. Initially attracted by the country’s engineering talent, TI established an R&D center in Bangalore, the first global technology company to set up such a facility in the country. In the last three decades, the India center has emerged as key R&D site. Today, TI is recognized in India for its talent and innovation, as well as for sowing the seeds of technology in the country.

Innovation
Innovation has been a hallmark of the company since its founding in the U.S. and throughout its 30 years of operating in India. Many of TI’s strategic businesses globally are integral to the R&D work that takes place in TI India. Almost every product that TI develops has the involvement and contribution of the company’s engineers in India. While semiconductor R&D is expected to become even more complex in the coming years as the deployment of electronics in various vertical segments increases, the depth and breadth of TI’s talent base in India equip the company to meet the challenges ahead.

India: A growing market opportunity
In the past decade, TI has recognized the semiconductor market potential in India. Today, with seven sales and applications support operations in eight cities across India, TI has the largest presence in the country amongst all the semiconductor companies. TI India has made significant inroads into various market segments like industrial, telecom, medical, consumer and automotive. TI India works closely with customers to design products for large emerging segments like industrial, automotive, energy, electronic manufacturing, education, and healthcare.

Kilby Labs India
In December 2010, TI set up Kilby Labs in Bangalore as the research program’s first international expansion outside the U.S. The Kilby Labs, named in honor of Jack Kilby, a TI engineer who invented the first integrated circuit in 1958, are focused on innovation in energy efficiency, bio-electronics and life sciences.

As the newest addition to TI’s R&D model, Kilby Labs bring together some of TI’s brightest minds to focus on breakthrough ideas. TI’s unique model in Kilby Labs spurs cross-team collaboration and gives engineers the time, space and resources to explore their ideas and invent completely new solutions to challenging problems.

From Kilby’s invention of the Integrated Circuit, throughout its history, TI has fuelled its growth in creating new markets through breakthrough innovations. Kilby Labs in India builds upon this principle - betting on the inventive minds and creating products that open up radically new opportunities for TI.

Awards:
• 2014: TI India sweeps Zinnov Awards for 5 categories - Thought Leadership, Technical Role Model, Innovation Potential to Solve Large Scale Problems, High Impact Global Roles, Ecosystem Enablement
• National Association for Software & Services Companies (NASSCOM), recognized TI among eight Top Innovating companies in India in 2008 and 2011, with NASSCOM’s Social Innovation Award 2011 recognizing TI India’s deployment of a new solar LED lantern that is bringing light to rural villages throughout the country.
• Center for Sustainable Development - Certificate of Recognition for dedication and commitment to energy conservation for the year 2011.

• Software Technology Parks of India (STPI) & Government of Karnataka - recognized as Top exporter from Karnataka in 2004 and 2008

• Was voted #1 “Great Place to Work®” in India by Business World in 2003

• EDN Asia Innovator of the Year - 2001, 2002, 2010

University Programs
As a leading technology company, TI helps prepare students around the world for the rigors of system design innovation when they graduate from college. Over the years, TI has worked with universities across India to impart knowledge of semiconductor technology and system design. TI works closely with over 1000 engineering colleges in the country. TI also works with many R&D services companies and has a robust third party program with companies that develop applications on TI platforms.

Internship/ New College Graduates Program
TI’s world class Internship and New College Graduate program focuses engaging with the top 20 universities across India. In 2011, TI India initiated a Master of Science (MS) Program jointly with Indian Institute of Technology, Madras for research associate positions working on cutting edge research in the area of Analog and Mixed Signal VLSI design. A similar MS program is also underway with IIT, Delhi.

Texas Instruments Science & Technology Quiz:
This Quiz in India, now in its 11th year, annually involves about 1,000 students in grades 8 to 10. This fun-filled math and science competition is one of the most popular student science quizzes in India.

Citizenship Initiatives
The TI India Citizenship team is a voluntary body of TI India employees, is active in environmental, education and other community activities.
The main objectives of the India citizenship program are:
• Enhance the quality of and access to education in India, especially those that support socioeconomic disadvantaged students and enhance gender equity.
• Improve the quality of life and meet the greatest needs in communities where TI operates in India, especially to support environment and healthcare.
• Encourage employee engagement and volunteerism and provide a platform for employees to pursue social causes.

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In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI’s goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or “enhanced plastic” are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have not been so designated is solely at the Buyer’s risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

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